

3.2x1.6 mm SMD CHIP LED LAMP

PRELIMINARY SPEC



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE **DEVICES**

Part Number: KPK-3216ZGC

GREEN

Features

- •3.2mmx1.6mm SMT LED, 1.1mm THICKNESS.
- •LOW POWER CONSUMPTION.
- •WIDE VIEWING ANGLE.
- •IDEAL FOR BACK LIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE: 2000PCS / REEL.
- •MOISTURE SENSITIVITY LEVEL: LEVEL 4.
- RoHS COMPLIANT.

Description

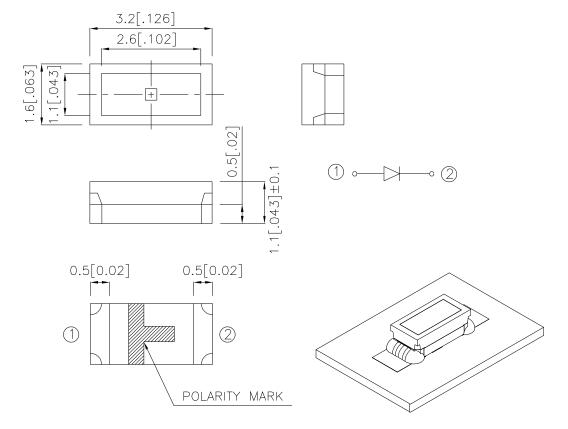
The Green source color devices are made with AllnGaN on Sapphire Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.2(0.008") unless otherwise noted.

 3. Specifications are subject to change without notice.
- 4. The device has a single mounting surface. The device must be mounted according to the specifications.





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Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) [2] @ 20mA Min. Typ.		Viewing Angle [1]
					201/2
KPK-3216ZGC	GREEN (AllnGaN)	WATER CLEAR	110	300	90°

Notes:

1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value. 2.Luminous Intensity / Luminous Flux: +/-15%.

Electrical / Optical Characteristics at T_A=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	515		nm	I==20mA
λD [1]	Dominant Wavelength	Green	525		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Green	30		nm	IF=20mA
С	Capacitance	Green	45		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	3.3	4.1	V	IF=20mA
lr	Reverse Current	Green		10	uA	VR = 5V

- 1. Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

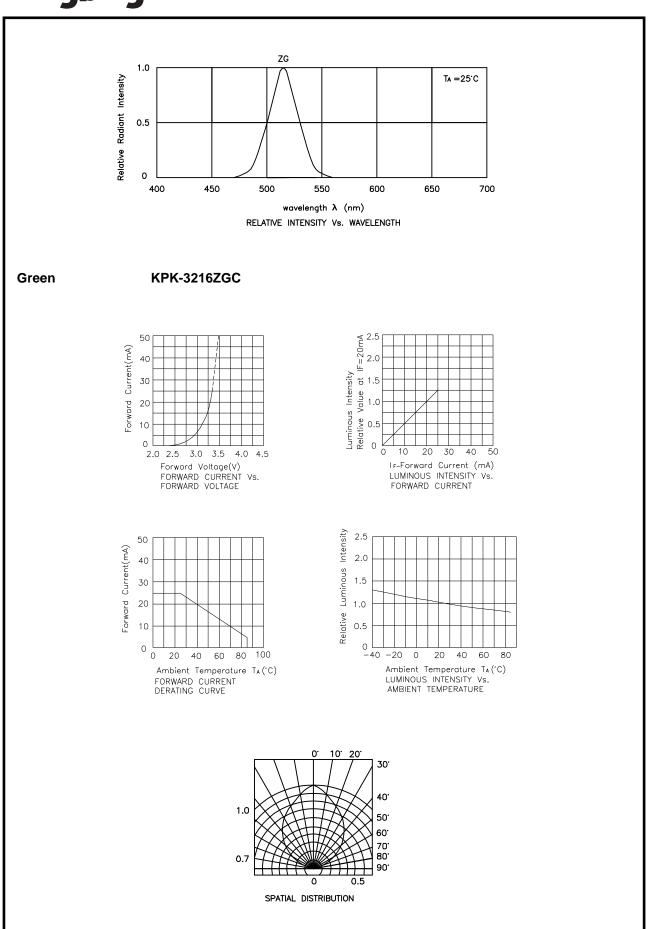
Absolute Maximum Ratings at Ta=25°C

Parameter	Green	Units
Power dissipation	102.5	mW
DC Forward Current	25	mA
Peak Forward Current [1]	150	mA
Reverse Voltage	5	V
Operating / Storage Temperature	-40°C To +85°C	

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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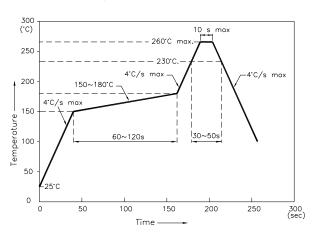


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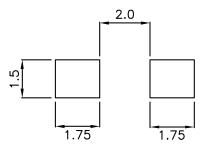
Reflow Soldering Profile For Lead-free SMT Process.



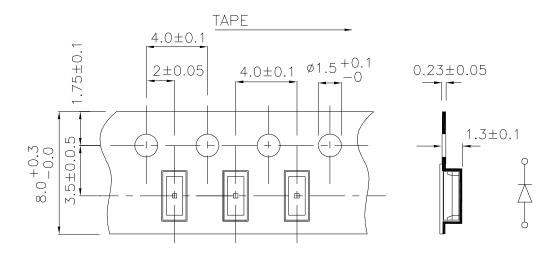
- NOTES: 1.We recommend the reflow temperature 245°C(\pm / \pm 5°C).The maximum soldering temperature should be limited to 260°C.
 - 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
 - 3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern

(Units: mm; Tolerance: ±0.1)



Tape Specifications (Units: mm)



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